

## Electronic Acknowledgement Receipt

<b>EFS ID:</b>	6087067
<b>Application Number:</b>	10596387
<b>International Application Number:</b>	
<b>Confirmation Number:</b>	5987
<b>Title of Invention:</b>	Epoxy Resin Molding Material for Sealing and Electronic Component
<b>First Named Inventor/Applicant Name:</b>	Kazuyoshi Tendou
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<b>Application Type:</b>	U.S. National Stage under 35 USC 371

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### File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/Message Digest	Multi Part/.zip	Pages (if appl.)
1		09-09-16_Amendment_B.pdf	160313 3d4bfa2ec9397d68016d6d7d75c9e4326cab38bf	yes	6

	<b>Multipart Description/PDF files in .zip description</b>								
	<b>Document Description</b>		<b>Start</b>	<b>End</b>					
	Amendment/Req. Reconsideration-After Non-Final Reject		1	1					
	Claims		2	4					
	Applicant Arguments/Remarks Made in an Amendment		5	6					
<b>Warnings:</b>									
<b>Information:</b>									
2	Transmittal Letter	09-09-16_IDS_After_Office_Action_With_Fee.pdf	44490 f6e6ca06bbb018c889b1d66a60bcd263269 0f400	no	2				
<b>Warnings:</b>									
<b>Information:</b>									
3	Information Disclosure Statement (IDS) Filed (SB/08)	09-09-16_Form_PTO_SB08a.pdf	608346 40e9ef93b0e7332c81e6dd3a99274c19df6 55e41	no	4				
<b>Warnings:</b>									
<b>Information:</b>									
A U.S. Patent Number Citation or a U.S. Publication Number Citation is required in the Information Disclosure Statement (IDS) form for autoloading of data into USPTO systems. You may remove the form to add the required data in order to correct the Informational Message if you are citing U.S. References. If you chose not to include U.S. References, the image of the form will be processed and be made available within the Image File Wrapper (IFW) system. However, no data will be extracted from this form. Any additional data such as Foreign Patent Documents or Non Patent Literature will be manually reviewed and keyed into USPTO systems.									
4	NPL Documents	NP01_Chemical_Dictionary_4.pdf	79052 2db64fb4efff6eda6562befb4e622de2a76 ba58	no	2				
<b>Warnings:</b>									
<b>Information:</b>									
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**New Applications Under 35 U.S.C. 111**

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

**National Stage of an International Application under 35 U.S.C. 371**

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

**New International Application Filed with the USPTO as a Receiving Office**

If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application.